

Summary

This application note describes a sample application that performs DALI (Digital Addressable Lighting Interface) communication using the RL78/G23 microcontroller.

The sample application operates as an Input Device. The supported DALI standards are as follows

- IEC 62386-101 Edition2.1 (hereafter 101ed.2.1)
- IEC 62386-103 Edition1.0 (hereafter 103ed.1.0)
- IEC 62386-304 Edition1.0 (hereafter 304ed.1.0)

To achieve standard-compliant communication, the waveforms of Manchester encoded DALI signals are processed using the peripheral functions in the RL78/G23.

This application note assumes that you already have a working knowledge of DALI; for more information on the DALI standard, see 6. Reference documents.

Target Device

RL78/G23

Notes: When applying this application note to other microcontrollers, please modify it to suit the specifications of the microcontroller and evaluate it thoroughly. DALI-2 certification is not a test for semiconductors or software. Please build the device as an Input Device that can support DALI-2 certification.



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1. Overview

This application note describes a sample application that implements the Input Device feature. The Input Device in this sample application has one Instance of Instance Type 4 (Light Sensor) and is linked to a Light Sensor as a physical signal processor. The Input Device has one Instance of Instance Type 4 (Light Sensor) and is linked to a Light Sensor) and is linked to a Light Sensor as a physical signal processor.

The Input Notification Event is a Forward Frame to notify the status of the signal processor. If you wish to dim the Control Gear on the DALI subnet, implement an application that sends a 16-bit Forward Frame corresponding to the Input Notification Event.

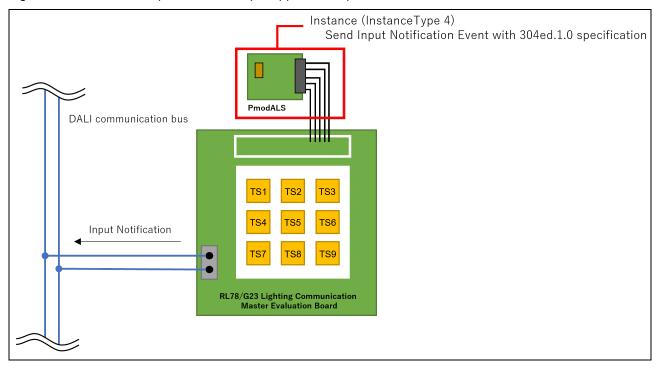


Figure 1-1 Overview of Input Device sample application operation



2. Operation confirmation conditions

The sample application has been tested in the following environments

Item	Contents
Microcontroller used	RL78/G23 (R7F100GGG2DFB)
Board used	RL78/G23 Lighting Communication Master Evaluation Board (RTK7RL23LMP00000BJ)
Input device	Light Sensor(PmodALS)
Operating Frequency	High-speed on-chip oscillator clock: 32 MHz
Operating Voltage	3.3V
Maximum current consumption (When DALI command is issued)	31.30mA
Integrated Development Environment (e2 studio)	Made by Renesas Electronics e2 studio 2022-04
C compiler (e2 studio)	Made by Renesas Electronics CC-RL V1.11.00
Integrated Development Environment (IAR)	Made by IAR Systems IAR Embedded Workbench IDE V4.21.4(NOTE)
C compiler (IAR)	Made by IAR Systems IAR C/C++ Compiler for Renesas RL78 V4.21.4
Library	Made by Renesas Electronics Renesas Flash Driver RL78 Type 01 V1.00 Made by Renesas Electronics EEPROM emulation software RL78 Type01 V1.00 Made by Renesas Electronics DALI103i library Gen2 V1.00 Made by Renesas Electronics DALI304 library Gen2 V1.00
Smart Configurator (SC)	V1.3.0 [Components used] Board Support Package (BSP) V1.20 SNOOZE mode sequencer (SMS) V1.0.1 Power supply detection circuit (LVD) V1.1.0

Table 2.1 Operation confirmation conditions

NOTE : When use IAR Embedded Workbench IDE V5 series, please clear all settings on "Custom tool configuration" . Please click Project - Option - Custom Build to open the custom tool configuration. Please clear below items : Filename extensions, Command line, Output files, Additional input files.

Category:			
General Options			
Static Analysis			
C/C++ Compiler	Custom Tool Co	nfiguration	
Assembler		and a store	
Output Converter	Eilename exter	aiona	
Custom Build			
Build Actions	Command line:		
Linker			
Debugger	Qutput files (or	ne per line):	
COM Port			-
E1			~
E2	Additional input	t files (one per line):	
E20	Teauceannia	time (and her may)	~
E2 Lite / E2 On-board			
EZ-CUBE			4
EZ-CUBE2	Build order:	Automatic (based on input and output)	~
Simulator			





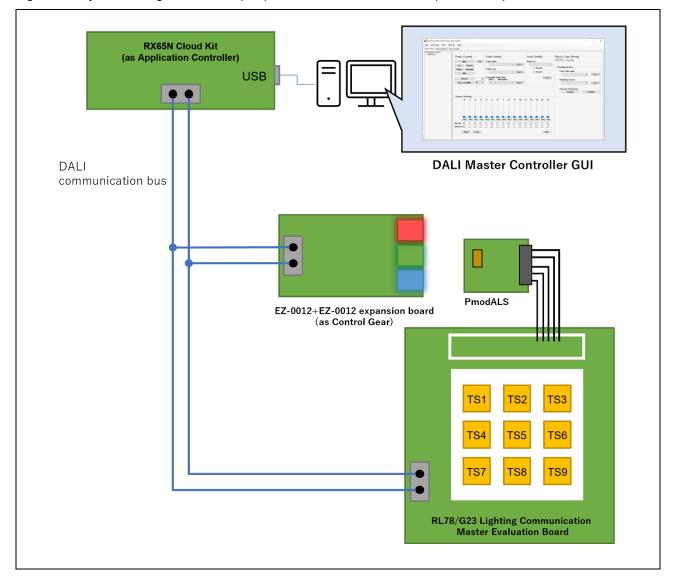
3. Hardware Description

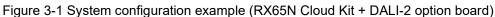
3.1 System Configuration

An example system configuration is shown below.

The sample application operates Input Device corresponding to RL78/G23 Lighting Communication Master Evaluation Board. The Input Device is a type of master device in the DALI system that notifies the DALI system of information from signal processing devices (switches, sensors, etc.) acquired by the Input Device. A separate Application Controller and Control Gear are required to configure a DALI system that uses the Input Device.

In this application note, the RX65N Cloud Kit+DALI-2 option board or RL78/G23 Lighting Communication Master Evaluation Board is used as the Application Controller. EZ-0012+EZ-0012 expansion board is used as the Control Gear.







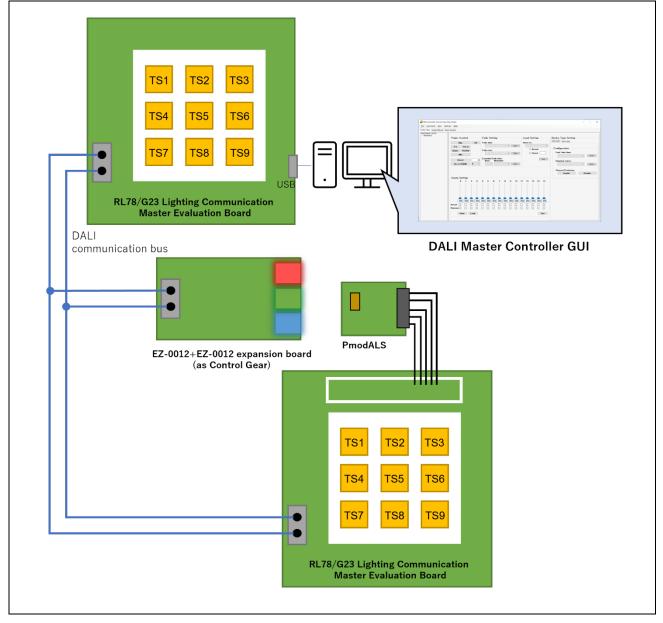


Figure 3-2 System configuration example (Using RL78/G23 Lighting Communication Master Evaluation Board)



3.2 List of pins used

The pins and features used in the sample application are shown below.

Table 3.1 Pins used and features

Pin name	Input/Output	Contents
P10	Output	DALI Communication (Transmit)
P16/TI01	Input	DALI Communication (Receive)
P14/SI20	Input	Light Sensor Serial Input
P15/SCK20	Output	Light Sensor Serial Clock Output
P27	Output	Light Sensor Chip Select Output

For other features related to the RL78/G23 Lighting Communication Master Evaluation Board, refer to the following.

- RL78/G23 Lighting communication master board initial firmware DALI communication modulation by SMS (R01AN6460)
- RL78/G23 Lighting Communication Master Evaluation Board User's Manual (R20UT5072EJ0102)



4. Software Description

4.1 How to build the environment (CC-RL)

4.1.1 Download software

The following software is required to run the sample application.

Please download it from the Renesas Electronics website.

- e2 studio
- Renesas Flash Driver RL78 Type 01 for RL78/G23
- EEPROM Emulation Software for RL78/G23 RL78 Type01
- DALI Master Controller GUI V3.00 or later

4.1.2 Install e2 studio

The e2 studio is required for program development and on-chip debugging of the sample applications.

For details on installation and other basic operations, refer to the User's Manual below.

 Integrated Development Environment e2 studio 2020-04, e2 studio v7.8 User's Manual: Getting Started Guide (R20UT4819)

4.1.3 Install Renesas Flash Driver RL78 Type 01 for RL78/G23

The sample application does not include the Renesas Flash Driver. Therefore, it is necessary to download the file from the Renesas Electronics website and register the file.

For installation, refer to the User's Manual below. For file registration, refer to section 4.1.8.

• Renesas Flash Driver RL78 Type01 User's Manual for RL78/G23 (R20UT4830)

4.1.4 Install EEPROM Emulation Software for RL78/G23 RL78 Type01

The sample application does not include EEPROM emulation software. Therefore, it is necessary to download the file from the Renesas Electronics website and register the file.

For installation, refer to the User's Manual below. For file registration, refer to section 4.1.8.

• EEPROM Emulation Software RL78 Type01 for RL78/G23 User's Manual (R20UT5008)



4.1.5 Install the DALI Master Controller GUI

The DALI Master Controller GUI is required for evaluation of sample applications.

Refer to the User's Manual below for the installation procedure.

• DALI Master Controller GUI User's Manual (R20UT0715)

In addition, firmware must be written to the application controller that communicates with the DALI master controller GUI. For the target firmware, use the hex file and mot file enclosed in the ZIP file provided when downloading the DALI master controller GUI installer.

4.1.6 Write firmware for EZ-0012+EZ-0012 expansion board

Firmware must be written for the Control Gear to check the operation of the sample application. Refer to the following for the procedure.

- DALI-2 Control Gear Basic (102) LED (207) Color Control (209Tc) Sample Application (R01AN6177)
- 4.1.7 Import Sample Applications
- 1. Unzip the provided project file and place it in the desired location (folder).
- 2. Start e2 studio and right-click in the Project Explorer or select the [File] \rightarrow [Import].
- 3. Select [General] → [Existing Projects into Workspace] and click [Next].
- 4. Select "Select root directory" and from [Browse] select the project file placed in step 1.
- 5. Select a sample application.
- 6. Click [Exit].

4.1.8 Locate Renesas Flash Driver / EEPROM Emulation Software

After importing the sample application, store the Renesas Flash Driver / EEPROM emulation software downloaded from Renesas Electronics in the following directory.



\DALI103i_304_sample <dir></dir>	
\Library <dir></dir>	
\RFD <dir></dir>	Folder that contains the Renesas Flash Driver.
\userown	Setup for this sample application
r_rfd_common_userown.c	
\include	Copy from RFD.
\rfd	
r_rfd.h	
r_rfd_compiler.h	
r_rfd_device.h	
r_rfd_memmap.h	
r_rfd_types.h	
r_typedefs.h	
r_rfd_common_api.h	
r_rfd_common_control_api.h	
r_rfd_common_userown.h	
r_rfd_data_flash_api.h	
\source	
\commom	
r_rfd_common_api.c	
r_rfd_common_control_api.c	
\dataflash	
r_rfd_data_flash_api.c	
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\userown \include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c	Setup for this sample application.
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\userown \include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h	Setup for this sample application.
\userown \include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_memmap.h	Setup for this sample application.
\userown \include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_types.h	Setup for this sample application.
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\userown \include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_types.h r_ees_types.h r_typedefs.h r_ees_api.h	Setup for this sample application.
\userown \include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_types.h r_ees_types.h r_typedefs.h r_ees_exrfd_api.h	Setup for this sample application.
\userown \include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_memmap.h r_typedefs.h r_ees_api.h r_ees_sub_api.h	Setup for this sample application.
\userown \include r_ees_descriptor.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_types.h r_ees_types.h r_typedefs.h r_ees_exrfd_api.h r_ees_sub_api.h	Setup for this sample application.
\userown \include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_types.h r_ees_types.h r_ees_memmap.h r_typedefs.h r_ees_sub_api.h \source \ees	Setup for this sample application.
\userown \include r_ees_descriptor.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_memmap.h r_typedefs.h r_ees_api.h r_ees_sub_api.h \source \ees r_ees_api.c	Setup for this sample application.
\userown \include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_types.h r_ees_types.h r_ees_memmap.h r_typedefs.h r_ees_sub_api.h \source \ees	Setup for this sample application.

Table 4.1 Location of Renesas Flash Driver / EEPF	ROM emulation software
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- 4.1.9 How to build the sample application
- 1. Right click on the project and select [Build Project].
- 2. Check the [Console] pane shows 'Build complete.' message to indicate a successful build.

4.1.10 Hardware connections and configuration switches for the sample application

4.1.10.1 How to connect Input Devices

The connection between the Light Sensor (PmodALS), which serves as the input device, and the RL78/G23 Lighting Communication Master Evaluation Board is shown below.

Table 4.2 Light Sensor Connection

RL78/G23 Lighting Communication Master Evaluation Board	Light Sensor (PmodALS)
CN2-15 (P27)	CS
CN2-8 (P14/SI20)	SDO
CN2-7(P15/SCK20)	SCK
CN2-2 (GND)	GND
CN2-42 (3.3V)	VCC



4.1.10.2 Jumper/Switch Settings

The jumpers, etc. on the RL78/G23 Lighting Communication Master Evaluation Board must be set as follows when operating this sample application.

Figure 4-1 RL78/G23 Lighting Communication Master Evaluation Board Components

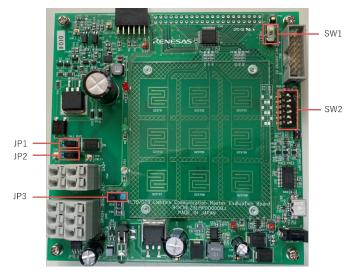


Table 4.3 List of switch settings

JP/SW Number	Setting
JP1	Open
JP2	Open
JP3	H side and short
SW1	don't care
SW2-1	OFF
SW2-2	ON
SW2-3	OFF
SW2-4	ON
SW2-5	OFF
SW2-6	ON



4.1.11 How to debug the sample application

- 1. After importing the sample application in e2 studio, click the button to download the program to the microcontroller.
- 2. Click [Run] \rightarrow [Debug Configurations...] to open the "Debug Configurations" window.
- 3. In the "Debug Configurations" window, expand the "Renesas GDB Hardware Debugging" debug configuration view and click on an existing debug configuration.
- 4. Switch to the [Debugger] \rightarrow [Connection Settings] tab and confirm that the settings are as shown below.

* When using E2 emulator Lite, select Debug hardware : E2 Lite (RL78).

Figure 4-2 Debug Screen Settings

🖹 Main ^I Debugger 🕨 Startup 💱 Source 🔲 Common			
Debug hardware: E2 Lite (RL78)	7F100GGG		
GDB Settings Connection Settings Debug Tool Settings			
✓ Clock			^
Main Clock Frequency[MHz]	Using Internal Clock	~	
Sub Clock Frequency[kHz]	Using Internal Clock	~	
Monitor Clock	System	~	
 Connection with Target Board 			
Emulator	(Auto)		
Low voltage OCD board	No	\sim	
Power Target From The Emulator (MAX 200mA)	No	~	
Supply Voltage[V]	3.3	\sim	
Hot Plug	No	\sim	
✓ Flash			
Current Security ID (HEX)	000000000000000000000000000000000000000		
Current Serial Programming Security ID (HEX)	FFFFFFFFFFFFFFFFFFFFFFFFFFFF		
Permit rewrite the serial programming security ID	No	\sim	
Permit Flash Programming	Yes	~	
Use Wide Voltage Mode	Yes	~	
Erase Flash ROM When Starting	Yes	~	
Program uses flash self programming	No	~	
Fill unused area with 0xFF when writing flash memo	ory No	\sim	Y

5. Select "Start Debugging" and when the "Debug" view screen appears, ready for debugging.

For details on debugging and other basic operations, please refer to the User's Manual below.

 Integrated Development Environment e2 studio 2020-04, e2 studio v7.8 User's Manual: Getting Started Guide (R20UT4819)



4.2 Environment construction (IAR)

4.2.1 Download Software

The following software is required to run the sample application.

Download from the IAR Systems website.

4.2.2 IAR Embedded Workbench for Renesas RL78

 IAR Embedded Workbench for Renesas RL78 is required for program development and on-chip debugging of the sample applications.
 Refer to the video below for installation.

Using Smart Configurator with IAR Embedded Workbench for RL78 (1/2) - Installation

4.2.3 Install the DALI Master Controller GUI

The DALI Master Controller GUI is required for evaluation of sample applications.

Refer to the User's Manual below for the installation procedure.

• DALI Master Controller GUI User's Manual (R20UT0715)

In addition, firmware must be written to the application controller that communicates with the DALI master controller GUI. For the target firmware, please use the hex file and mot file enclosed in the ZIP file provided when downloading the DALI master controller GUI installer.

4.2.4 Write firmware for EZ-0012+EZ-0012 expansion board

Firmware must be written for the Control Gear to check the operation of the sample application. Refer to the following for the procedure.

• DALI-2 Control Gear Basic (102) LED (207) Color Control (209Tc) Sample Application (R01AN6177)

4.2.5 Import Sample Applications

- 1. Start IAR Embedded Workbench for Renesas RL78.
- 2. Select [File] -> [New Workspace].
- 3. Select [File] -> [Save Workspace As] to place the workspace in any name and location (folder).
- 4. Unzip the provided project file and place it in the workspace (folder) created.
- 5. Select [Project] -> [Add Existing Project] and select the project file (EWP file) placed in step 9.
- 6. Select [File] -> [Exit].

4.2.6 Locate Renesas Flash Driver / EEPROM emulation software

After importing the sample application, store the Renesas Flash Driver / EEPROM emulation software downloaded from Renesas Electronics in the following directory.



\DALI103i_304_sample <dir></dir>	
\Library <dir></dir>	
\RFD <dir></dir>	Folder that contains the Renesas Flash Driver.
luserown	Setup for this sample application
r_rfd_common_userown.c	
\include	Copy from RFD.
\rfd	
r_rfd.h	
r_rfd_compiler.h	
r_rfd_device.h	
r_rfd_memmap.h	
r_rfd_types.h	
r_typedefs.h	
r_rfd_common_api.h	
r_rfd_common_control_api.h	
r_rfd_common_userown.h	
r_rfd_data_flash_api.h	
\source	
\commom	
r_rfd_common_api.c	
r_rfd_common_control_api.c	
\dataflash	
r_rfd_data_flash_api.c	
\EES <dir></dir>	Folder for storing EEPROM emulation software.
luserown	Setup for this sample application.
\include	
\include r_ees_descriptor.h	
\include r_ees_descriptor.h r_ees_user_types.h	
\include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c	Setup for this sample application.
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\include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_memmap.h	Setup for this sample application.
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\include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees.h r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_types.h r_typedefs.h r_ees_api.h r_ees_sub_api.h	Setup for this sample application.
\include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_types.h r_ees_types.h r_ees_types.h r_ees_types.h r_ees_types.h r_ees_types.h r_typedefs.h r_ees_sub_api.h r_ees_sub_api.h	Setup for this sample application.
\include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_types.h r_ees_types.h r_typedefs.h r_ees_sub_api.h \source \ees	Setup for this sample application.
\include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_types.h r_tees_memmap.h r_typedefs.h r_ees_api.h r_ees_sub_api.h \source \ees r_ees_api.c	Setup for this sample application.
\include r_ees_descriptor.h r_ees_user_types.h r_ees_descriptor.c \include \ees r_ees_compiler.h r_ees_defines.h r_ees_device.h r_ees_types.h r_ees_types.h r_typedefs.h r_ees_sub_api.h \source \ees	Setup for this sample application.

Table 4.4 Location of Renesas Flash Driver / EEPROM emulation software



- 4.2.7 How to build the sample application
- 1. Right-click on the project in the workspace and select [Make].
- The build will start and the "console" will display the status of the build. The build is complete when the message "Total number of errors: 0" is displayed.

4.2.8 Hardware connections and configuration switches for the sample application

4.2.8.1 How to connect Input Devices

The connection between the Light Sensor (PmodALS), which serves as the input device, and the RL78/G23 Lighting Communication Master Evaluation Board is shown below.

Table 4.5 Light Sensor Connection

RL78/G23 Lighting Communication Master Evaluation Board	Light Sensor (PmodALS)
CN2-15 (P27)	CS
CN2-8 (P14/SI20)	SDO
CN2-7(P15/SCK20)	SCK
CN2-2 (GND)	GND
CN2-42 (3.3V)	VCC



4.2.8.2 Jumper/Switch Settings

The jumpers, etc. on the RL78/G23 Lighting Communication Master Evaluation Board must be set as follows when operating this sample application.

Figure 4-3 RL78/G23 Lighting Communication Master Evaluation Board Components

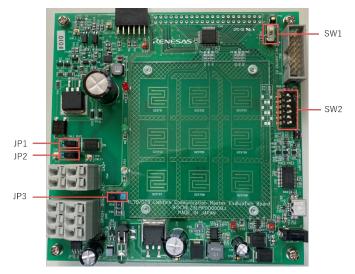


Table 4.6 List of switch settings

JP/SW Number	Setting
JP1	Open
JP2	Open
JP3	H side and short
SW1	don't care
SW2-1	OFF
SW2-2	ON
SW2-3	OFF
SW2-4	ON
SW2-5	OFF
SW2-6	ON



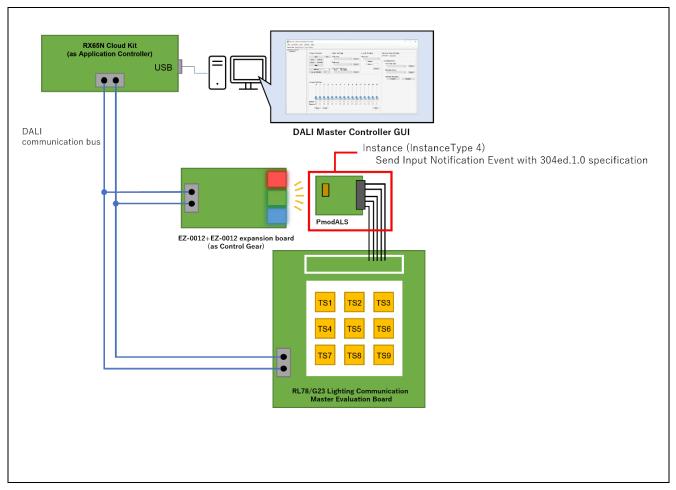
4.2.9 How to debug the sample application

1. After importing the sample application in IAR Embedded Workbench for Renesas RL78, click the button to download the program to the microcontroller and debug it.



4.3 Overview of Operation

The following is an overview of the operation of this sample application.





This sample application operates as an Input Device device in the DALI standard. The Input Device in this sample application has one Instance of Instance Type 4, and the Instance corresponds to a Light Sensor. The Instance – Input Device correspondence table is shown in Table 4.7.

The Light Sensor acquires the LED illuminance level of the Control Gear and sends an Input Notification Event to the DALI communication bus according to the illuminance level.



Table 4.7 Instance – Input Device	correspondence table
-----------------------------------	----------------------

Instance Number	Input Device	resolution (bit)	Input Signal
0	Light Sensor	8	0 - 255

In addition, the following Event Information is defined for Instance Type 4 Instances, and an Input Notification Event occurs when each of the conditions is met. Refer to the IEC62386-304ed1.0 standard for the conditions under which each Event occurs.

Table 4.8 List of Event Information

Event Info	rmation	Description
Event Details Event Info value (binary value)		
illuminance level report	xx xxxx xxxxb	Illuminance level obtained from Light Sensor (encoded as 10-bit value)

The processing corresponding to the Event Message sent by the Input Device in this sample application (such as sending dimming instruction commands to the Control Gear) should be implemented in the Application Controller on the same DALI subnet.



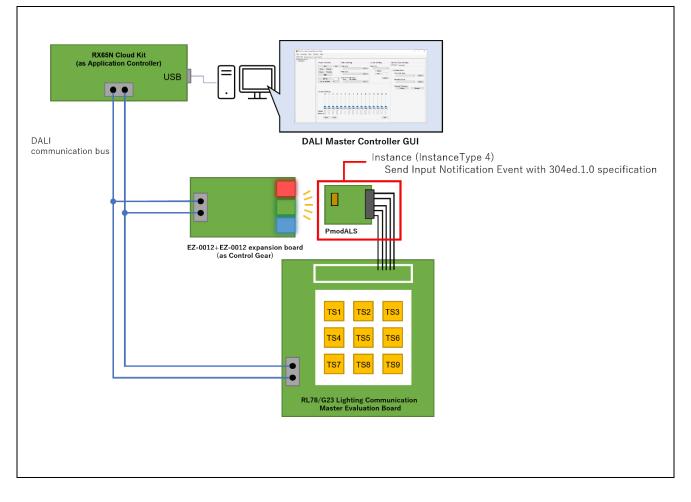
4.4 Operating Procedure

This application note describes the procedure for running the sample application using the DALI master controller GUI as follows.

An example of using the RX65N Cloud kit + DALI-2 option board as the Application Controller is shown below.

When using the RL78/G23 Lighting Communication Master Evaluation Board as the Application Controller, refer to 3.1 to connect devices. Connect an AC adapter to the RX65N Cloud kit + DALI-2 Option Board and configure the settings so that the power supply to the DALI bus is sufficient.







[Procedure]

- 1. After connecting RX65N Cloud kit + DALI-2 option board, RL78/G23 Lighting Communication Master Evaluation Board, EZ-0012 + EZ-0012 expansion board as the Application Controller, and then supply power to each device.
- 2. After building the sample application, download the program from the debugger to the RL78/G23 Lighting Communication Master Evaluation Board and execute debugging.
- 3. After starting the DALI master controller GUI, make a serial connection to the RX65N Cloud kit + DALI-2 option board.
- 4. Open Bus Monitor View on the DALI master controller GUI screen.
- 5. From the Control Gear tab of the DALI master controller GUI, send a dimming command via Broadcast to change the illuminance of the LEDs on the EZ-0012+EZ-0012 expansion board.
- 6. Confirm that the Input Notification Event corresponding to the LED illumination level is generated on the Bus Monitor View of the DALI master controller GUI.

Figure 4-6 Input Notification Event Confirmation

Bus Monitor View	×
Clear	
[11111111 00000101] BECALL MAX LEVEL [10001000 10000011 11010011] Event Message Event info(Illuminance level)	^
<	×

If the Input Notification Event does not occur by the above procedure, try moving the LED and Light Sensor (PmodALS) on the EZ-0012+EZ-0012 expansion board closer together.

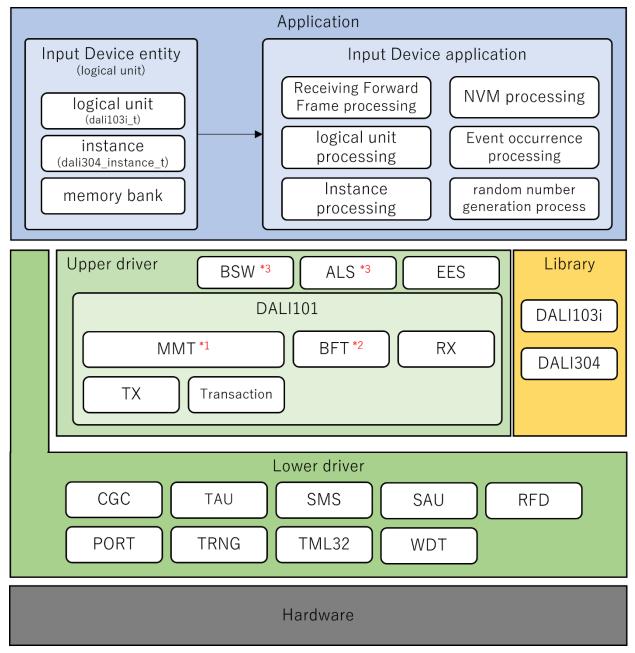


4.5 Feature Overview

4.5.1 Feature block diagram

A feature block diagram of the sample application is shown below.

Figure 4-7 Feature block diagram



- *1 MMT • Multi Master Transmitter
- *2 BFT • Backward Frame Transmitter
- *3 BSW • Binary Switch
- *4 ALS • PmodALS



4.5.2 Lower driver layer

It is a simple driver layer using the RL78/G23's peripheral features.

4.5.2.1 CGC

This driver performs clock generation. This sample application uses the Smart Configurator (SC) and has the following settings.

Figure 4-8 Clock setting

Clocks configuration							
Operation mo	e: High-speed main mo	ode 2.7(V)~5.5(V)	•				
EVDD setting:	1.6 V ≤ EVDD0 ≤ 5.5	V	•				
√ High-spee	on-chip oscillator		7			fIHP	
Frequency:	32	▼ (MHz)	•			- 32 fMAIN	(MHz)
					•	- 32	(MHz)
					´ Lol	fCLK 32000	(kHz)
Middle-sp	ed on-chip oscillator					fIMP	
Frequency:	4	▼ (MHz)				-	(MHz)
X1 oscillat	or		Divider				
Operation mo	K1 oscillation	Ŧ	x1 *			fMXP	
Frequency:	5	(MHz)				-	(MHz)
Stable time:	2^18/fx	▼ 52428.8(µs)					
			_			fIL	
Low-speed or Frequency:	chip oscillator 32.768	(kHz)		•		32.768	(kHz)
	32.708	(K112)					
XT1 oscillator						fSXP 32.768	(kHz)
Operation mo	e: XT1 oscillation	v					(
Frequency:		(kHz)				fSXR	(kHz)
XT1 oscillation	mode: Low power const	umption 1 🔹 👻					
Supply mode:		n STOP,HALT mode 🛛 👻					



4.5.2.2 PORT

This driver enables port control of the RL78/G23 microcontroller. In this sample application, a driver that enables control of all ports of the on-board microcontroller is implemented and called as required.

Contents	Input/Output	Usage	
P01/RxD1	Input	For DMX512	
P00/TxD1	Output	For DMX512	
P10	Output	For DALI transmission	
P11	Input	For debugger connection	
P12	Output	For debugger connection	
P13	Output	Unused	
P14/SI20	Input	Light Sensor Serial Input	
P15/SCK20	Output	Light Sensor Serial Clock Output	
P16/TI01	Input	For DALI reception (input pulse width measurement)	
P17	Output	Unused	
P20	Output	DMX512	
P21	Output	PMOD	
P22	Output	PMOD	
P23	Output	PMOD	
P24	Output	PMOD	
P25	Input	Unused	
P26	Output	Unused	
P27	Output	Light Sensor chip select output	
P30	Input	Unused	
P31/TS01	Output	Unused	
P40/TOOL0	Input	For debugger connection	
P41/TO07	Output	Unused	
P50/TS00	Input	Unused	
P51	Output	Unused	
P60/SCLA0	Output	PMOD	
P61/SDAA0	Output	PMOD	
P62	Output	LED (red)	
P63	Output	LED (green)	

Table 4.9 Port settings (1/2)



Contents	Input/Output	Usage
P70/TS02	Input	Unused
P71/TS03	Input	Unused
P72/TS04	Output	LED (white)
P73/TS05	Output	Unused
P74/TS06	Output	Unused
P75/TS07	Output	Unused
P120	Output	Unused
P121	Output	Unused
P122	Output	Unused
P123	Input (input-only port)	Unused
P124	Input (input-only port)	Unused
P130	Output (output-only port)	Unused
P137/INTP0	Input (input-only port)	Unused
P140	Output	Unused
P146 ^{Note}	FOR_PROBIT_LAB macro disabled:	FOR_PROBIT_LAB macro disabled:
	Output	Unused
	FOR_PROBIT_LAB macro enabled:	FOR_PROBIT_LAB macro enabled:
	Input (internal pull-up resistor enabled)	ProbitLab digital switch 1 connection status input
P147	Output	Unused
RESET	-	Unused
REGC	-	Unused
VSS	-	Unused
VDD	-	Unused

Table 4.1 Port settings (2/2)

Note: The FOR_PROBIT_LAB macro is only required when carrying out a test sequence for DALI-2 certification. When carrying out the test sequence, enable the FOR_PROBIT_LAB macro, connect the P146 and GND pins to ProbitLab's digital switch 1 and carry out the test sequence. If the test sequence is not carried out, it should be disabled to avoid false detection of the Push Switch input status. The FOR_PROBIT_LAB macro is defined in the following locations

e2studio: Open the project properties, select [C/C++ Build] -> [Settings] -> [Tool Settings] ->

[Compiler] -> On the [Source] screen, [Macro definition]

IAR : From the project options, on the [C/C++ Compiler] -> [Defined symbols] on the [Preprocessor] screen.



4.5.2.3 TAU

This driver controls timers using a timer array unit. In this sample application, each channel is configured as follows according to the application.

Table 4.10 Timer array unit settings

Channel	Setting	Interrupt priority	Usage
TAU0 CH0	Interval timer (1ms)	Interrupt not used	1ms periodic process synchronisation of applications
TAU0 CH1	Input pulse width measurement	Priority 0	Pulse width measurement of DALI RxD pin
TAU0 CH2	Interval timer (50us)	Priority 1	Idle/Active state continuation time measurement of DALI RxD pins
TAU0 CH3	Interval timer (1458us)	Priority 3	Active state transmission time of Corrupted Backward Frame
TAU0 CH4	Interval timer (optional)	Priority 3	For processing when a collision occurs
			- Active State transmission time of tBreak (1200-1400us)
			 Loopback time (50ms) from waveform transmitted from DALI TxD pin to received at DALI RxD pin
TAU0 CH5	Unused	-	-
TAU0 CH6	Unused	-	-
TAU0 CH7	Unused	-	-

4.5.2.4 TRNG

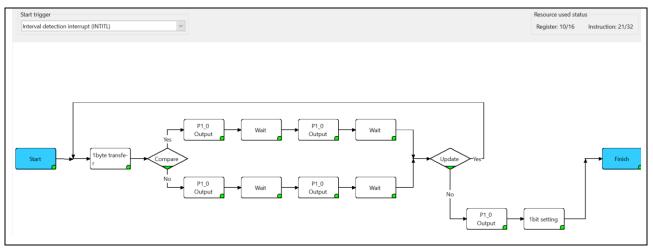
It is a driver that uses a true random number generator.



4.5.2.5 SMS

This driver uses the SNOOSE mode sequencer (hereafter SMS). In this sample application, the SMS is used to modulate the DALI transmission. The following settings are made using the Smart Configurator (SC).

Figure 4-9 SMS settings



The specifications of the SMS process to be performed with the above settings are given below.

Table 4.11 SMS settings

Overview	DALI waveform output processing by SMS			
Description	(1) The SMS is activated by an INTITL interrupt.			
	(2) The waveform is transmitted according to the data by judging the 1-bit data from the argument.			
	 Bit data == 0: Output to P10 (DALI TxD pin) in the order of 1 → 0 in the Wait time width. 			
	 Bit data == 1: Output to P10 (DALI TxD pin) in the order of 0 → 1 in the wait time width. 			
	(3) When all data transmission is completed, the output of port P10 is set to High, MK0H bit4 (SMSEMK) is set to Zero generating an SMS termination interrupt (INTSMSE).			
	(4) The finish function terminates SMS process.			
Argument ^{Note1}	address d: Transmission data start address			
5	address e: Transmission data end address			
Return value	None			
Remark	The bit width of the waveform output with reference to the DALI TxD pin varies with the rise or fall delay in the DALI communication circuit external to the microcontroller; adjustment is required so that the waveform output on the DALI communication bus complies with the standard. For details, see chapter 4.5.6.2 of the RL78/G23 DALI-2 Input Device Basic (103)			
	Sample Application Note.			



4.5.2.6 TML32

This driver uses a 32-bit interval timer. In this sample application, each channel is configured as a 4-channel 8-bit counter mode as follows according to the application.

Table 4.12 32-bit interval timer settings

Channel	Setting	Interrupt priority	Usage
TML32 CH0	Interval timer (16us)	Non-	SMS activation trigger
TML32 CH1	Unused	interruptible	-
TML32 CH2	Unused		-
TML32 CH3	Unused		-

4.5.2.7 SAU

This driver uses the Serial Array Unit.

4.5.2.8 WDT

This driver uses a watchdog timer. This driver restarts the watchdog timer.

Refer to 4.6.2 List of optional byte settings for information on setting the watchdog timer.

4.5.2.9 RFD

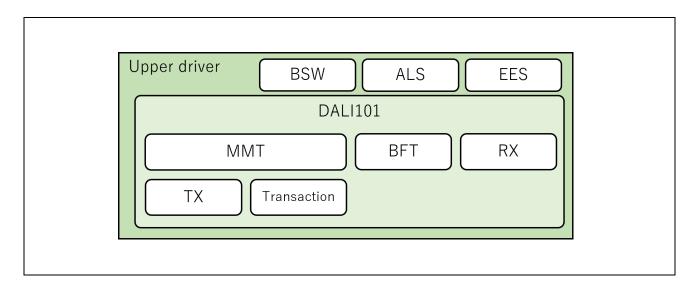
This driver reads and writes to the RL78/G23 data flash. This sample application uses Renesas Flash Driver from Renesas Electronics.

For details, refer to Renesas Flash Driver RL78 Type01 User's Manual for RL78/G23 (R20UT4830).



4.5.3 Upper driver layer

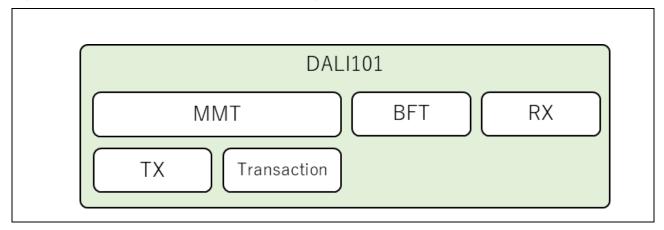
Highly functional drivers that are realized by combining lower-level drivers.



4.5.3.1 DALI101 communication driver

The DALI communication driver of this sample application has the following configuration.

Figure 4-10 DALI101 communication driver configuration





(1) DALI101

API function group for the DALI101 communication driver.

Within this module, implement features to acquire the state of the DALI RxD pin (RxD level duration and receive bit width) and pass it to the MMT and RX described below.

• DALI RxD level duration measurement

Start/restart the 50 us interval timer (Timer Array Unit 0 Channel 2) triggered by an edge detection on the DALI RxD pin. The duration of the RxD level (High/Low) is measured by adding 100 us to the duration in the timer's interrupt handler.

• DALI RxD receive bit width measurement

The receive bit width is measured using the input pulse interval measurement feature of the Timer Array Unit for the DALI RxD pin.

However, as each measurement time is based on the microcontroller terminal reference, it varies with the rising or falling delay in the DALI communication circuit external to the microcontroller, resulting in an error in the acquisition time. For this reason, a delay correction is made in consideration of the delay in the DALI communication circuit before being passed on to the MMT and RX.

Refer to 4.5.6 Threshold value and calibration for more information on corrections and thresholds.

Other functions are implemented to wrap MMT, BFT and RX function groups.

(2) Multi-Master Transmitter (MMT)

This module realizes DALI's Multi-Master Transmitter provision.

It starts transmitting the DALI Frame registered by the user at the appropriate settling time corresponding to the "priority". It also checks the loopback received data during transmission to see if a collision has occurred.

If a collision occurs, transmission is aborted and appropriate recovery processing is performed.

(3) Backward Frame Transmitter (BFT)

This module is used to transmit Backward Frames.

Transmitting a valid 8-bit Backward Frame is achieved by using the Transmitter (TX) described below, while transmitting a Corrupted Backward Frame is achieved by setting the DALI TxD pin to output Low for 1.458ms and then High.

Corrupted Backward Frame refers to a damaged Backward Frame caused by the collision of multiple Backward Frames. When there are multiple logical DALI devices in a DALI device and each device has different Backward Frame data contents, the Backward Frames are aggregated and transmitted as a Corrupted Backward Frame.



(4) Receiver (RX)

This module realizes the Receiver provisions of DALI.

The DALI RxD receive bit width/bit level (High/Low) received from the upper driver DALI101 is sequentially stored in a ring buffer and the Stop Condition and System Failure are detected by the DALI RxD level duration time.

When a Stop Condition is detected, Frame reception is regarded as complete and whether or not the frame satisfies the DALI standard is checked from each bit width/bit level (High/Low) stored in the ring buffer until then.

If the frame is a normal frame, information on whether or not the same frame was received within the previous 100 ms is also provided.

(5) Transaction (TRANSACTION)

Buffer module for Frame transmission, including Transaction specifications (a group of frames that make sense in a series of frames).

(6) Transmitter (TX)

This module transmits Frames up to 32 bit using SMS and TML32.



4.5.3.2 EES

This software is designed to perform EEPROM emulation features using the RL78/G23's data flash. This sample application uses Renesas Electronics EEPROM emulation software.

For more information, refer to EEPROM Emulation Software RL78 Type01 for RL78/G23 User's Manual (R20UT5008).

4.5.3.3 BSW

Driver for acquiring the input status of Binary Switches (abbreviated BSW), including bouncing (unstable decrease that temporarily repeats ON/OFF when the setting status changes) measures by specifying the pin to which the Binary Switch is connected.

4.5.3.4 ALS

This driver obtains the input level of PmodALS (abbreviated as ALS). By specifying the SAU (lower driver) channel to which the sensor is connected, the illuminance level from the sensor can be acquired.

4.5.4 Library layer

The DALI103i and DALI304 libraries are used as libraries for Input Device in DALI communication.



4.5.5 Application layer

4.5.5.1 Secure Input Device entity

Secure Instance and logical unit entities according to the specifications of the Input Device. In this sample application, the elements required for one logical unit are grouped in the logical_unit_t structure before allocating the entity.

4.5.5.2 Input Device application

(1) Forward Frame processing on receipt

This analyses the received Forward Frame, executes the command and transmits the Backward Frame.

(2) logical unit processing

This sample application is a single logical unit; multiple logical units can be implemented if more than 32 Instances are required.

(3) Instance Processing

This processes the signal processor. Implement the processing according to the signal processor used.

This sample application uses PmodALS as the signal processor for the Light Sensor.

(4) NVM processing

This performs the data flash storage process. In this sample application, it is implemented in the EES and RFD libraries.

(a) Autosaving

As the DALI standard requires that the NVM variable save its state at least 30 seconds before power-off, this sample application automatically saves any changes to the NVM variable every second. If you want to reduce the number of writes to the data flash, either increase the save frequency or only write when power off is detected.

(b) Manual saving

To save NVM variables explicitly, send the "SAVE PERSISTENT VARIABLES" command from the Application controller.

After receiving this command, save all NVM variables within 300 ms.

- (5) Event processing
- (a) POWER NOTIFICATION

This event is used to notify power supply reconnection.

Transmit at random timings between 1.3s and 5s from the start of power supply to the Input Device.

(b) INPUT NOTIFCATION

Events can be issued according to the state of the signal processor. When implementing Instance Type 1 to 31, implement according to the corresponding standard (301 to 331); when implementing with Instance Type 0, the user should define the specification.



(6) Random number generation process

This generates random numbers for use in the DALI103i library. The conditions for the random numbers to be generated are as follows.

- It should be generated in the range [0x000000, 0xFFFFE].
- The same value is not generated even if the generation is repeated at least as many times as the number of logical units.
- * When implementing pseudo-random numbers, the seed value must be a genuine random number.



4.5.6 Threshold value and calibration

For the contents of this chapter, refer to the same chapter in RL78/G23 DALI-2 Input Device Basic (103) Sample Application Note.



RL78/G23 DALI-2 Input Device Light Sensor(304) Sample Application

4.6 Software configuration

This section describes the software configuration of the sample application.

4.6.1 Folder structure

The folder structure of this sample application is shown below.

Table 4.13 Folder structure (1/2)

Folder, File name	Description	
DALI103i_304_sample	Folder containing the sample application	
VApp	Folder containing the application program	
r common.h	Common definition header file	
r input device.c	Input Device module source file	
r_input_device.h	Input Device module header file	
r it4 instance.c	Instance Type 4 source file	
r it4 instance.h	Instance Type 4 header file	
r main.c	Main source file	
r_memory_bank.c	Main source file	
r_memory_bank.h	Memory bank module header file	
r_memory_banks.c	Source file for modules managing multiple memory banks	
r_memory_banks.h	Header file for modules managing multiple memory banks	
	Source file for NVM modules supporting data flash libraries	
r_nvm.c r_nvm.h	Header file for NVM modules supporting data flash libraries	
-		
r_random.c	Source file for random number generation modules	
r_random.h	Header file for random number generation modules	
r_unit0_memory_bank.c	Source file for unit0 definition of memory banks	
r_unit0_memory_bank.h	Header file for unit0 definition of memory banks	
\Driver	Folder containing the driver program PmodALS driver source file	
r_als.c	PmodALS driver header file	
r_als.h		
r_bsw.c	Binary Switch driver source file	
r_bsw.h	Binary Switch driver header file	
r_dali101.c	DALI101ed.2.0 compliant driver source file	
r_dali101.h	DALI101ed.2.0 compliant driver header file	
r_dali101_bft.c	DALI101ed.2.0 compliant driver (Backward Frame transmission) source file	
r_dali101_bft.h	DALI101ed.2.0 compliant driver (Backward Frame transmission) header file	
r dali101 common.h	DALI101ed.2.0 common definition header file	
r dali101 mmt.c	DALI101ed.2.0 compliant driver (Multi Master transmission) source file	
r dali101 mmt.h	DALI101ed.2.0 compliant driver (Multi Master transmission) header file	
r dali101 rx.c	DALI101ed.2.0 compliant driver (Receive) source file	
r dali101 rx.h	DALI101ed.2.0 compliant driver (Receive) header file	
r dali101 transaction.c	DALI101ed.2.0 compliant driver (transaction) source file	
r dali101 transaction.h	DALI101ed.2.0 compliant driver (transaction) header file	
r_dali101_tx.c	DALI101ed.2.0 compliant driver (transmission) source file	
r dali101 tx.h	DALI101ed.2.0 compliant driver (transmission) header file	
r port.c	Source file for PORT	
r port.h	Header file for PORT	
r_sau.c	Source file for SAU	
r sau.h	Header file for SAU	
r tau.c	Source file for TAU	
r tau.h	Header file for TAU	
1_tau.11		



RL78/G23 DALI-2 Input Device Light Sensor(304) Sample Application

Table 4.14 Folder structure (2/2)

Folder, File name	Description
DALI103i_304_sample	Folder containing the sample application
\Driver	Folder containing the driver programs
r_tml32.c	Source files for TML32
r_tml32.h	Header file for TML32
r_trng.c	Source files for TRNG
r_trng.h	Header file for TRNG
r_wdt.c	Source file for WDT
r_wdt.h	Header file for WDT
\HardwareDebug	Folder containing project output files
DALI103i_304_sample.mot	Motorola S-type format files used for writing to firmware
\Library	Library storage folder
\DALI103i	Folder for DALI103ed1.0 compliant libraries
\DALI304	Folder for DALI304ed1.0 compliant libraries
\EES	Library storage folder for EES
\RFD	Library storage folder for RFD
\src	Storage folder for smart configurator generation files
smc_gen	Folder for smart configurator generation
Utility	Common program storage folder
r_timer16.c	Timer module source file
r_timer16.h	Timer module header file
 r_usertype.h	Type definition header file

4.6.2 List of optional byte settings

The optional byte settings for the sample application are shown below.

Table 4	.15 List d	of optional	byte settings
		optional	byte settings

Address	Set value	Description
000C0H / 040C0H	11101111B	Watchdog timer operation permitted
		 After reset is released, counting stops
		 Overflow time: 2¹⁷/f_{IL} (3478.26 ms)
000C1H / 040C1H	11111101B	LVD reset mode (falling: 2.91 V, rising: 2.97 V)
000C2H / 040C2H	11101000B	HS mode, high-speed on-chip oscillator: 32 MHz
000C3H / 040C3H	10000100B	On-chip debugging permitted



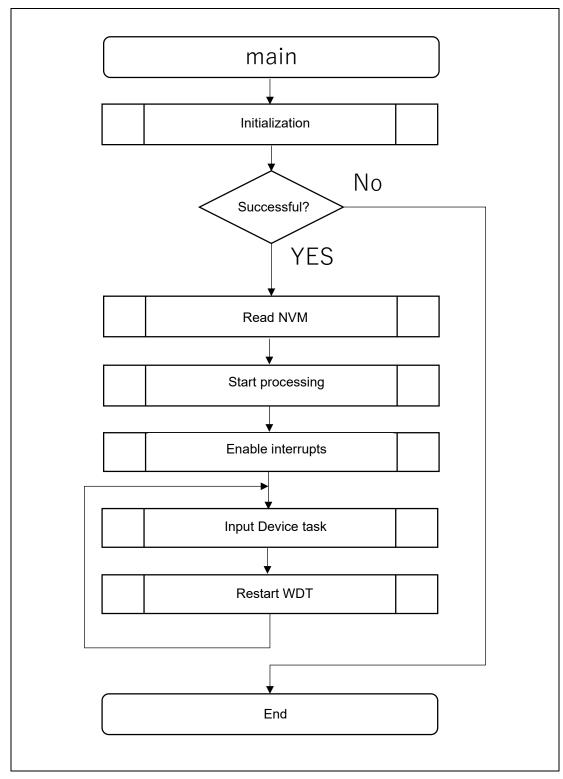
4.6.3 Flowcharts

4.6.3.1 Main flow

The main flow of the sample application is shown below.

After the initialization process is completed, the Input Device process is executed.

Figure 4-11 Main flow chart

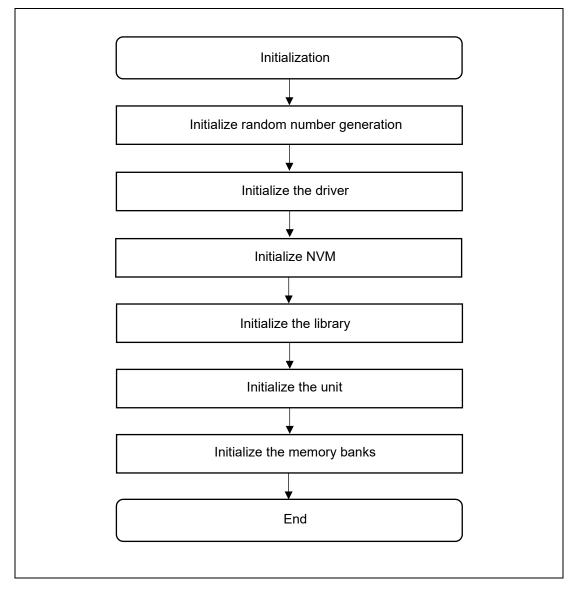




4.6.3.2 Initialization

The flow of the initialization process is shown below.

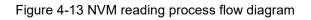
Figure 4-12 Initialization process flow diagram

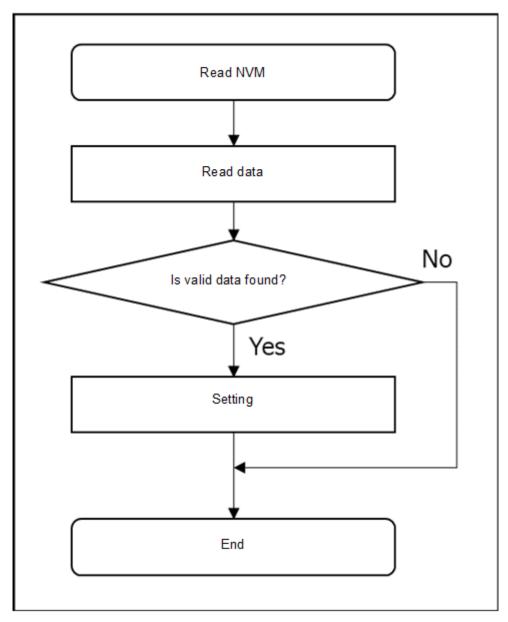




4.6.3.3 NVM reading

The flow of the NVM loading process, which is carried out after the initialization process, is shown below.

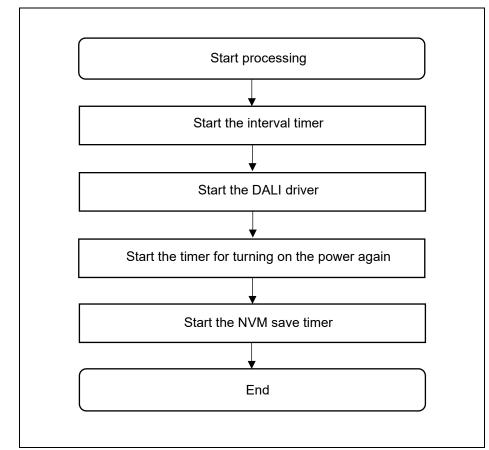


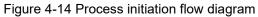




4.6.3.4 Start of processing

The flow for starting the process, which is carried out after the NVM read process, is shown below.



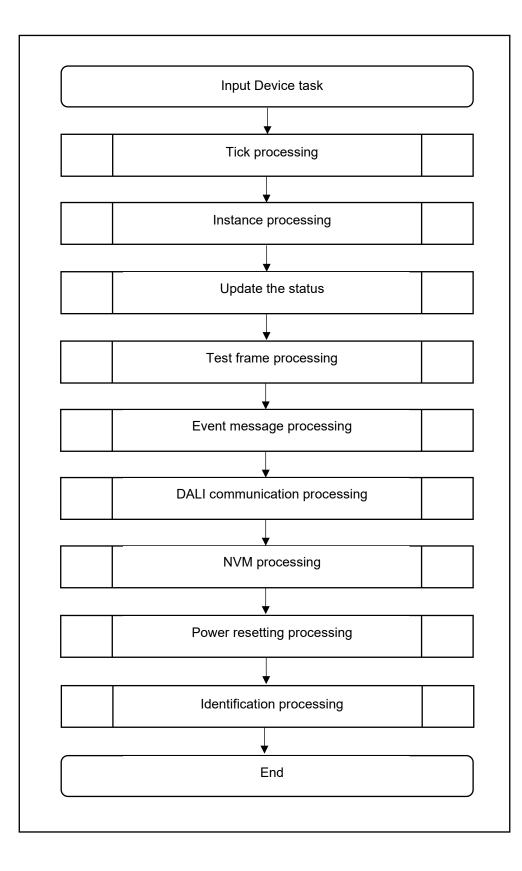




4.6.3.5 Input Device task processing

The flow of Input Device task processing is shown below.

Figure 4-15 Input Device task processing flow diagram





5. Notes

- This sample application is configured and operated in accordance with the board RL78/G23 Lighting Communication Master Evaluation Board.
- The operation provided by this sample application is only a sample. The application layer should be redesigned and evaluated according to the intended use.

6. Reference documents

RL78/G23 User's Manual: Hardware (R01UH0896EJ0110)

RL78 Family User's Manual: Software (R01US0015J)

Integrated Development Environment e2 studio 2020-04, e2 studio v7.8 User's Manual: Getting Started Guide (R20UT4819)

DALI Master Controller GUI User's Manual (R20UT0715)

RL78/I1A DC/DC LED Control Evaluation Board (EZ-0012) (R01UH0363)

DALI-2 Control Gear Basic (102) LED (207) Color Control (209Tc) Sample Application (R01AN6177)

(Please obtain the latest version from the Renesas Electronics website.)

Technical Update / Technical News

(Please obtain the latest version of information from Renesas Electronics website.)

DALI standards

IEC 62386-101:2014+AMD1:2018 CSV Consolidated version (ed.2.1) IEC 62386-103:2014+AMD1:2018 CSV Consolidated versioned (ed.1.1) IEC 62386-304:2017 (ed.1.0)



RL78/G23 DALI-2 Input Device Light Sensor(304) Sample Application

Revision History

		Description	
Rev.	Date	Page	Summary
1.00	Nov. 08, 2023		



General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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